

# LCD MODULE

# SPECIFICATION



For Customer's Acceptance

Approved by	Comment

Approved by	Reviewed by	Prepared by

### 2. Revision Record

Date	Rev.N o.	Page	Revision Items	Prepared	
20&%%%&)	V1		The first release	Sally	
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### 3. General Specifications

IC, FPC, a back light unit. The 10.1'' display area contains  $1024 \times 600$  pixels and can display up to 16M colors. This product accords with RoHS environmental

Item	Contents	Unit	Note
LCD Type	TFT	-	
Display color	16M		1
Viewing Direction	6	O'Clock	
Operating temperature	-20~+70	°C	
Storage temperature	-20~+70	°C	小百
Module size	235x143 x5.0	mmstr	2
Active Area(W×H)	222.72 x 125.28	mm	
Number of Dots	1024×RGB×600	dots	
Power Supply Voltage	ED JEN 3.8 NICS	V	
Outline Dimensions	Refer to outline drawing	-	
Backlight	42-LEDs (white)	pcs	
Data Transfer	R G B	-	

criterion.

Note 1: Color tune is slightly changed by temperature and driving voltage.

Note 2: Without FPC and Solder.

### 4. Outline. Drawing



### 5. Absolute Maximum Ratings(Ta=25°C)

#### 5.1 Electrical Absolute Maximum Ratings.(Vss=0V ,Ta=25°C)

Item	Symbol	Min.	Max.	Unit	Note
Power Supply Voltage	V <sub>CC</sub>	-0.3	3.6	V	
Logic Signal Input /Output Voltage	V <sub>IOVCC</sub>	-0.3	V <sub>CC</sub> +0.5	V	1 2
Power Supply Voltage for LCD	Vop	0	3.6	V	1, 2
Current of LED	ILED	0	FI €	mA	

Notes:

1. If the module is above these absolute maximum ratings. It may become permanently damaged,

Using the module within the following electrical characteristic conditions are also exceeded, the

module will malfunction and cause poor reliability.

- 2.  $V_{CC}$  > $V_{SS}$  must be maintained.
- 3. Please be sure users are grounded when handing LCD Module.

#### 5.2 Environmental Absolute Maximum Ratings.

Itom	Stor	age	Operat	Note	
	MIN.	MAX.	MIN.	MAX.	Note
Ambient Temperature	-20°C	70°C	-0°C	ï 0℃	1,2
Humidity	-	-	-	-	3

- 1. The response time will become lower when operated at low temperature.
- 2. Background color changes slightly depending on ambient temperature.

The phenomenon is reversible.

3. Ta<=40°C:85%RH MAX.

Ta>=40°C:Absolute humidity must be lower than the humidity of 85%RH at 40°C.

# 6. Electrical Specifications and Instruction Code

6.1	Electrical	characteristics	(Vss=0V	,Ta=25°C)
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Parameter		Symbol	Condition	Min	Тур	Max	Unit	Note
Power sup	pply	VCC	Ta=25°C	2.6	3.3	3.6	V	
Input	'H'	VIH	V <sub>CC</sub> =2.8V	0.8V <sub>CC</sub>	-	V <sub>CC</sub>	V	
voltage	'L'	V <sub>IL</sub>	V <sub>CC</sub> =2.8V	0	-	0.2V <sub>CC</sub>	V	
Current		I <sub>CC1</sub>	Normal mode	-	-	-	mA	2
Consump	tion	I <sub>CC2</sub>	Sleep mode	-	0.03	0.09	mA	12

Note:

1:When an optimum contrast is obtained in transmissive mode. RONICS LI

IE

NCER

2: Tested in 1×1 chessboard pattern.

#### 6.2 LED backlight specification(VSS=0V ,Ta=25°C)

Item	Symbol	Condition	Min	Тур	Max	Unit	Note
Supply voltage	-	-	16.2	17	19.2	V	1
Supply current	۱ <sub>f</sub>	-	-	140	-	mA	2

Note:

1: VLED=VLED(+)-VLED(-).

A LED drive in constant current mode is recommended.

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# 6.3 Interface signals

Pin No.	Symbol	Function
1-4	NC	NC
5	GND	Ground
6	VCOM	Common voltage 3.3V
7	DVDD	Power for Digital Circuit
8	MODE	DE/SYNC mode select
9	DE	Data Enable Input
10	VSYNC	Vertical Sync Input
11	HSYNC	Horizontal Sync Input
12-19	B7-B0	Blue Data Bit
20-27	G7-G0	Green Data Bit
28-35	R7-R0	Red Data Bit / DX0-DX7
36	GND	Ground
37	DCLK	Dot Data Clock 800*480 MIN 33MHz 1024*600 Min 52MHz
38	GND	Ground
39	L/R	Left/Right selection
40	U/D	Up/Down selection
41	VGH	Gate ON Voltage 18V
42	VGL	Gate OFF Voltage -8.0V
43	AVDD	Power for Analog Circuit 10.3V
44	RESET	Reset pin,This is an active low signal
45	NC	NC
46	VCOM	Common voltage 3.3V
47	DITHB	Dithering function
48	GND	Ground
49-50	NC	NC
	i	

### 7. Optical Characteristics

	Item	Sy	mbol	Condition	Min.	Тур.	Max.	Unit	Note	
	Brightness	E	Зр	<i>θ</i> =0°		400	-	Cd/m <sup>2</sup>	1	
	Uniformity	Ζ	]Bp	Φ <b>=0</b> °	75	80	-	%	1,2	
		3	:00		-	70	-			
	Viewing	6	:00	Cr>10	-	70	-	Dog	2	
	Angle	9	:00	CI210	-	70	-	Deg	5	
		12	2:00		-	50	-			
	Contrast Ratio	(	Cr	<i>e</i> =0°	-	600		-	4	司
	Response Time	T,	+T <sub>f</sub>	Φ <b>=</b> 0°		84	展	ms	5	
			х	1 th	0.235	0.287	0.337	11-		
		W	у	七智识	0.263	0.313	0.363	-		
		K	+Y	TELEC	1 P	-	-			
		1	x	ERLE	0.538	0.588	0.638	-		
		R	у		0.298	0.348	0.398	-		
-	Color of		Y		-	-	-			
	Coordinate		х	<i>θ</i> =0° Φ=0°	0.281	0.331	0.381	-	1,6	
		G	у	Φ-0	0.533	0.583	0.633	-		
			Y		-	-	-			
			х		0.101	0.151	0.201	-		
		В	у		0.075	0.125	0.175	-		
			Y		-	-	-			
	NTSC Ratio		S		-	50	-	%		

Note: The parameter is slightly changed by temperature, driving voltage and materiel

Note 1: The data are measured after LEDs are turned on for 5 minutes. LCM displays full white. The brightness is the average value of 9 measured spots. Measurement equipment PR-705 (Φ8mm) Measuring condition:

- Measuring surroundings: Dark room.
- Measuring temperature: Ta=25℃.
- Adjust operating voltage to get optimum contrast at the center of the display.

Measured value at the center point of LCD panel after more than 5 minutes while backlight turning on.



Note 3: The definition of viewing angle: Refer to the graph below marked by  $\theta$  and  $\Phi$ 



Note 5: Definition of Response time. (Test LCD using DMS501):

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figure as below.



The definition of response time

Note 6: Definition of Color of CIE Coordinate and NTSC Ratio.



Note 7: Definition of cross talk.

Cross talk ratio(%)=|pattern A Brightness-pattern B Brightness|/pattern A Brightness\*100



Electric volume value=3F+/-3Hex

### 8. Reliability Test Items and Criteria

No	Test Item	Test condition	Criterion
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ITEM	Inspection
Contrast	CR>50%
IDD	IDD<200%
Brightness	Brightness>60%
Color Tone	Color Tone+/-0,05

#### 9 Quality level

#### 9.1 Classification of defects

Major defects (MA): A major defect refers to a defect that may substantially degrade usability for product applications, including all functional defects(such as no display, abnormal display, open or missing segment, short circuit, missing component), outline dimension beyond the drawing, progressive defects and those affecting reliability.

Minor defects (MI): A minor defect refers to a defect which is not considered to be able to substantially degrade the product application or a defect that deviates from existing standards almost unrelated to the effective use of the product or its operation, such as black spot, white spot, bright spot, pinhole, black line, white line, contrast variation, glass defect, polarizer defect, etc.

#### 9.2 Definition of inspection range

Glass defect



		PCB defect	Componen	ts assei	mbly det	fect		
9.4 Outgoing Inspection level								
Outgoing Inspection standard		Inspection conditions		Inspection				
				Min.	Max.	Unit	IL	AQL
Major Defects Se		See 8.3 general	See 8.3 general notes		See 8.5		II	0.065
Minor Defects See 8.3 general r		notes	See 8.5		II	0.065		
Note: Sampling standard conforms to GB2828								

### 9.5 Inspection Items and Criteria

	9.5 Inspection It	ems and Criteria				、司			
				Judgment standard					
	Inspec	tion items		Category	Acceptable r	number			
	[			141	A zone	B zone			
	Black spot, White spot, Pinhole, Foreign Particle, Particle in or on glass, Scratch on glass	ite b b a b b b b b b b b b b b b b b b b	A	Φ<=0.20	Neglected	Neglected			
			в	0.20<Φ<=0.25	3	Neglected			
1			С	0.25<Ф<=0.3	2	Neglected			
			D	0.3<Ф<=0.4	3				
		(a/b<2.5)	Е	0.4<Ф<=0.5	0	2			
			То	tal defective point(B,C)	1	-			
	Black line, White line, and Particle Between Polarizer and glass, Scratch on glass	ack line, White e, and Particle tween larizer and lass, Scratch on lss	А	W<=0.03	Neglected	Neglected			
			В	0.03 <w<=0.05 L&lt;=3.0</w<=0.05 	3	Neglected			
2			с	0.05 <w<=0.1 L&lt;=3.0</w<=0.1 	2	Neglected			
2			D	0.05 <w<=0.1 L&lt;=4.0</w<=0.1 	1	3			
			E	W>0.1 L>4.0	0	2			
			Total defective point(B,C)		1	-			
3	Bright spot			any size	none	none			
4	Contrast		А	Ф<0.2	Neglected	Neglected			

	variation		В	0.2<Ф<=0.3	2		
		$ \begin{array}{c} b \\ \hline \\ a \\ \Phi = (a+b)/2(mm) \end{array} $	С	0.3<Ф<=0.4	1		
			D	0.4<Φ	0		
			Total defective point(B,C)		3		
5	Bubble inside cell			any size	none	none	
	Polarizer defect	Scratch ,damage on polarizer, Particle on polarizer or between polarizer and glass.	Re				
6	(if Polarizer is used)	Bubble, dent and convex	A	Ф<=0.1	Neglected	Neglected	
			В	0.1 <Ф<=0.2	2	Neglected	
				0.2 <Ф<=0.3	TIR	2	
7	Surplus glass	Stage surplus glass	B<=0.3mm				
8	Open segment or open common			t permitted			
0							
3	Short circuit		Not permitted				
10	False viewing direction		Not permitted				
11	Contrast ratio uneven		According to the limit specimen				
12	Crosstalk		According to the limit specimen				
13	Black /White spot(display)			Refer to item 1			
14	Black /White line(display)		Refer to item 2				

		Judgment standard			
	Inspection items			Category(application: B zone)	Acceptable number
		i ) The front of lead terminals	A	a≤ t, b≤1/5W, c≤3mm	
		w t a c	В	Crack at two sides of lead terminals should not cover patterns and alignment mark	
15	Glass	ii ) Surrounding crack-non-contact side seal c b a t Inner border line of the seal Outer border line of the seal	b	Inner borderline of the seal	Max.3
	crack	iii) Surrounding crack- contact side seal c b a <u>Inner border line of the seal</u> Outer border line of the seal	b <	< Outer borderline of the seal	allowed
		iv)Corner	A	a <= t, b <= 3.0, c <= 3.0	
		w b c	а	patterns u and alignment mark and patterns.	

Inspection items			Judgment standard		
			Category(application: B zone)		
16	PCB defect	Component soldering: No cold soldering, short, open circuit, burr, tin ball The flat encapsulation component position deviation must be less than 1/3 width of the pin (Pic.1); the sheet component deviation: Pin deviates from the pad and contact with the near components is not permitted (Pic.2)	Component $L \leq W/2$ W Soldering pad Lead $L \geq 0$ Lipo		
		lead defect: The lead lack must be less than 1/3 of its width; The lead burr must be less than 1/3 of the seam; Impurities connect with the near leads is not permitted	e电发展有限公司 ENICS LIMITED		
		Connector soldering: Soldering tin is at contact position of the plug and socket is not permitted No foundation is scald Serious cave distortion on plug and socket contact pin is not permitted	Soldering tin is not permit in this area Soldering tin is not permit in this area		

### 10. Precautions for Use of LCD Modules

#### **10.1 Handling Precautions**

- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
  - Isopropyl alcohol
  - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 10.1.6 Do not attempt to disassemble the LCD Module.

10.1.7 If the logic circuit power is off, do not apply the input signals.

- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
  - a. Be sure to ground the body when handling the LCD Modules.
  - b. Tools required for assembly, such as soldering irons, must be properly ground.
  - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
  - d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

#### **10.2 Storage precautions**

10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.

10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature :  $0^{\circ}C \sim 40^{\circ}C$ 

Relatively humidity: ≤80%

- 10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.